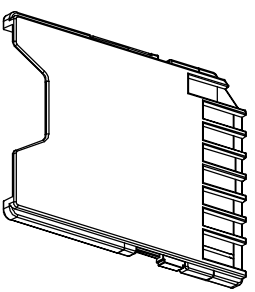
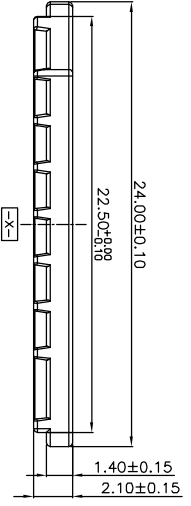
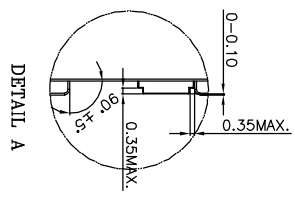
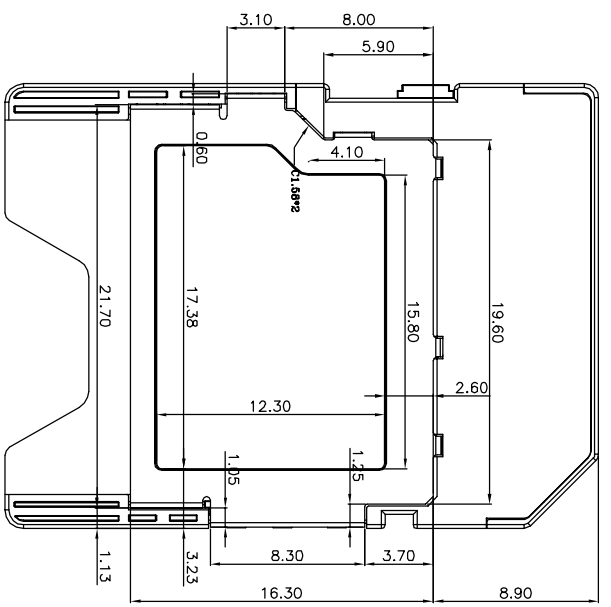
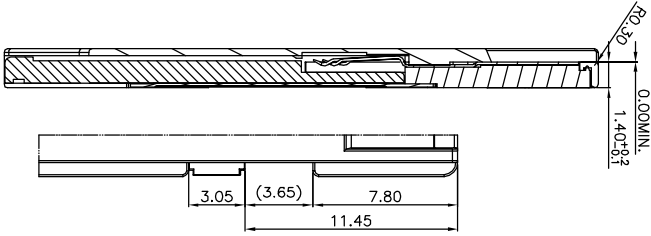
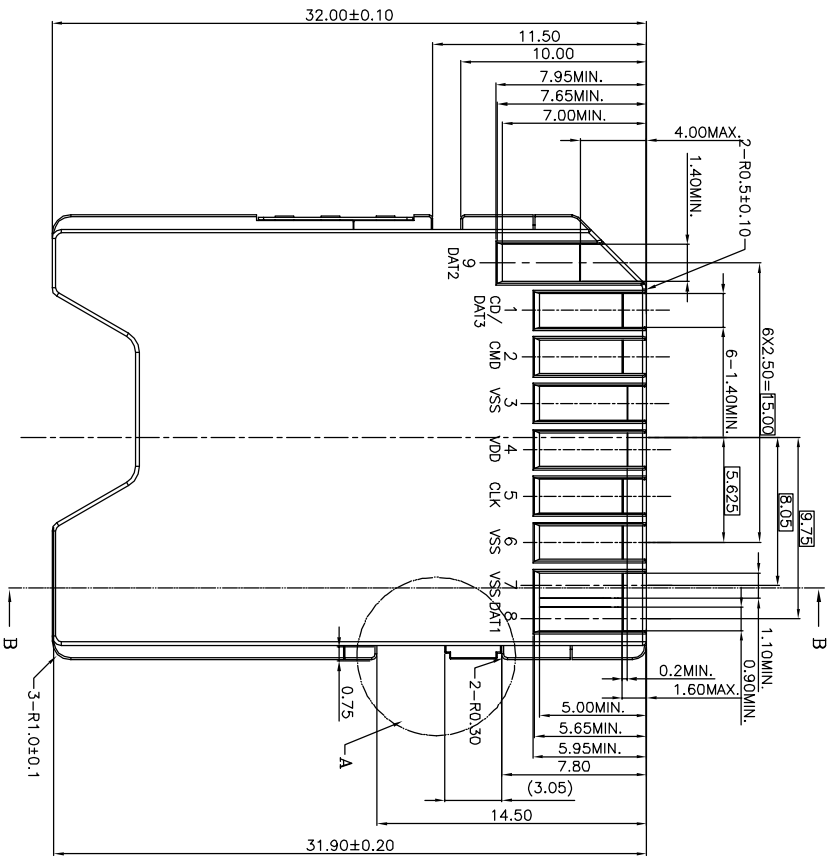


REV.	ECN NO.	MODIFY CONTENT	DATE
A	ES100601.045	Initial	04/18/2006
B	ES100604.055	add shell dimension	04/18/2006



- NOTE:
- Contact Resistance: 100mΩ Max.
 - Dielectric Withstanding Voltage: 500VAC Max with 1 Minute
 - Insulation Resistance: 1000 MΩ Min.
 - Current Rating: 1 A AC/DC Max.
 - Rated Voltage: 500 V RMS Min.
 - Mini SD Card extraction force: 1.5N MIN.
 - Durability: 10,000 mating cycles.
 - Operating Temperature: -25°C ~ +85°C
 - Storage Temperature: -45°C ~ +85°C

THE PART NUMBER:
106-00120-**-**



- Selective gold 1u" on contact area over nickel plated 80u"
- Selective gold 3u" on contact area over nickel plated 80u"
- Selective gold 5u" on contact area over nickel plated 80u"
- Selective gold 10u" on contact area over nickel plated 80u"
- Selective gold 15u" on contact area over nickel plated 80u"
- Selective gold 30u" on contact area over nickel plated 80u"
- Selective gold 50u" on contact area over nickel plated 80u"

GENERAL	TOLERANCE	FILE NO.	PART NO.	DRAWN	WYX	MATERIAL	SCALE	NO SCALE
X.±0.50	X.±.5*	106-00120	106-00120-**-**	WYX	Terry	04/18/2006	UNIT	MM
X.±0.38	X.±.2*	REV. B	TITLE MINISD Adapter(shell)	CHECKED	Jeffrey	DATE	SCALE	NO SCALE
.XX±0.25	.XX±.1*	REV. A4	SHEET 1 OF 1	APPROVED	Jeffrey	Amphenol Shouhmin Industry	UNIT	MM